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By Page

- Surface Science (Nix) - [CC BY-NC-SA 4.0](#)
 - Front Matter - [CC BY-NC-SA 4.0](#)
 - TitlePage - [CC BY-NC-SA 4.0](#)
 - InfoPage - [CC BY-NC-SA 4.0](#)
 - Table of Contents - [Undeclared](#)
 - Licensing - [Undeclared](#)
 - 1: Structure of Solid Surfaces - [CC BY-NC-SA 4.0](#)
 - 1.1: Introduction - [CC BY-NC-SA 4.0](#)
 - 1.2: Miller Indices (hkl) - [CC BY-NC-SA 4.0](#)
 - 1.3: Surface Structures- fcc Metals - [CC BY-NC-SA 4.0](#)
 - 1.4: Surface Structures- hcp Metals - [CC BY-NC-SA 4.0](#)
 - 1.5: Surface Structures- bcc metals - [CC BY-NC-SA 4.0](#)
 - 1.6: Energetics of Surfaces - [CC BY-NC-SA 4.0](#)
 - 1.7: Relaxation and Reconstruction - [CC BY-NC-SA 4.0](#)
 - 1.8: Particulate Metals - [CC BY-NC-SA 4.0](#)
 - 1.9: Other Single Crystal Surfaces - [CC BY-NC-SA 4.0](#)
 - 2: Adsorption of Molecules on Surfaces - [CC BY-NC-SA 4.0](#)
 - 2.1: Introduction to Molecular Adsorption - [CC BY-NC-SA 4.0](#)
 - 2.2: How do Molecules Bond to Surfaces? - [Undeclared](#)
 - 2.3: Kinetics of Adsorption - [CC BY-NC-SA 4.0](#)
 - 2.4: PE Curves and Energetics of Adsorption - [CC BY-NC-SA 4.0](#)
 - 2.5: Adsorbate Geometries and Structures - [CC BY-NC-SA 4.0](#)
 - 2.6: The Desorption Process - [CC BY-NC-SA 4.0](#)
 - 3: The Langmuir Isotherm - [CC BY-NC-SA 4.0](#)
 - 3.1: Introduction - [CC BY-NC-SA 4.0](#)
 - 3.2: Langmuir Isotherm - derivation from equilibrium considerations - [CC BY-NC-SA 4.0](#)
 - 3.3: Langmuir Isotherm from a Kinetics Consideration - [CC BY-NC-SA 4.0](#)
 - 3.4: Variation of Surface Coverage with Temperature and Pressure - [CC BY-NC-SA 4.0](#)
 - 3.5: Applications - Kinetics of Catalytic Reactions - [CC BY-NC-SA 4.0](#)
 - 4: UHV and Effects of Gas Pressure - [CC BY-NC-SA 4.0](#)
 - 4.1: What is UltraHigh Vacuum? - [Undeclared](#)
 - 4.2: Why is UHV required for surface studies ? - [Undeclared](#)
 - 4.E: UHV and Effects of Gas Pressure (Exercises) - [CC BY-NC-SA 4.0](#)
 - 5: Surface Analytical Techniques - [CC BY-NC-SA 4.0](#)
 - 5.1: Surface Sensitivity and Surface Specificity - [CC BY-NC-SA 4.0](#)
 - 5.2: Auger Electron Spectroscopy - [CC BY-NC-SA 4.0](#)
 - 5.3: Photoelectron Spectroscopy - [CC BY-NC-SA 4.0](#)
 - 5.4: Vibrational Spectroscopy - [CC BY-NC-SA 4.0](#)
 - 5.5: Secondary Ion Mass Spectrometry - [CC BY-NC-SA 4.0](#)
 - 5.6: Temperature-Programmed Techniques - [CC BY-NC-SA 4.0](#)
 - 6: Overlayer Structures and Surface Diffraction - [CC BY-NC-SA 4.0](#)
 - 6.1: Classification of Overlayer Structures - [CC BY-NC-SA 4.0](#)
 - 6.2: Low Energy Electron Diffraction (LEED) - [CC BY-NC-SA 4.0](#)
 - 6.3: Reflection High Energy Electron Diffraction (RHEED) - [CC BY-NC-SA 4.0](#)
 - 6.4: Examples - Surface Structures - [CC BY-NC-SA 4.0](#)
 - 7: Surface Imaging and Depth Profiling - [CC BY-NC-SA 4.0](#)
 - 7.1: Basic concepts in surface imaging and localized spectroscopy - [CC BY-NC-SA 4.0](#)

- 7.2: Electron Microscopy - SEM and SAM - *CC BY-NC-SA 4.0*
- 7.3: Imaging XPS - *CC BY-NC-SA 4.0*
- 7.4: SIMS - Imaging and Depth Profiling - *CC BY-NC-SA 4.0*
- 7.5: Auger Depth Profiling - *CC BY-NC-SA 4.0*
- 7.6: Scanning Probe Microscopy - STM and AFM - *CC BY-NC-SA 4.0*
- Back Matter - *CC BY-NC-SA 4.0*
 - Index - *CC BY-NC-SA 4.0*
 - Index - *Undeclared*
 - Glossary - *CC BY-NC-SA 4.0*
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